

## Dual 4-Channel Analog Multiplexer/Demultiplexer

### Features

- Wide Power Supply Range: 2.5V to 5.5V
- On-Resistance: 42 Ω (TYP) at 5.0V
- -3dB Bandwidth: 550MHz
- Break-Before-Make Switching
- Rail-to-Rail Signal Range
- High Off-Isolation: -83dB (f=1MHz)
- Low Crosstalk: -95dB (f=1MHz)
- Operation Temperature Range:  
-40°C to +125°C
- Available in SOP16 package

### Applications

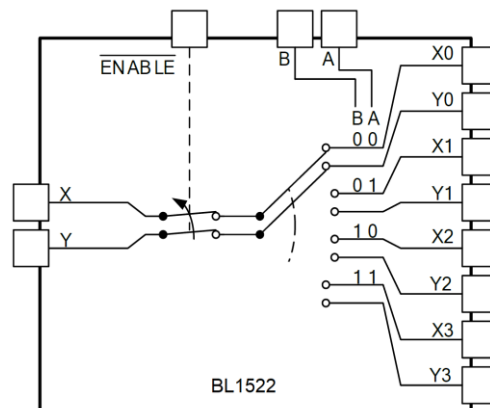
- Sensors
- Audio and Video Signal Routing
- Communications Circuits
- Battery-Operated Equipment
- Factory Automation
- Medical instruments

### Description

The BL1522 is a dual 4-Channel Analog Multiplexers and Demultiplexers designed for 2.5V to 5.5V  $V_{CC}$  operation. It has low on-resistance (42Ω TYP) and very low off-leakage current (1nA TYP). The BL1522 devices handle both analog and digital signals.

The BL1522 is available in SOP16 package.

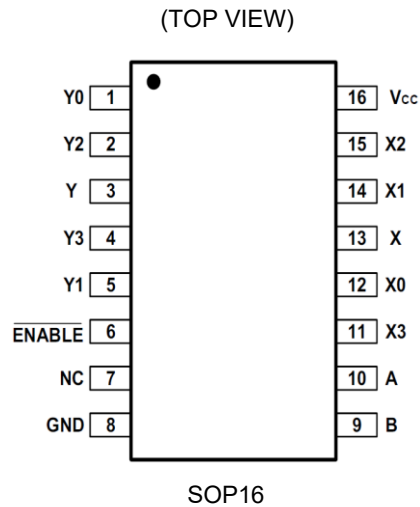
### Functional Diagrams of BL1522



### Ordering Information

Order No.	Package	Packing
BL1522SO	SOP16	Tape and Reel, 2500

## Pin Configurations



## Pin Description

NAME	PIN (SOP16)	FUNCTION
X0 – X3	12,14,15,11	Analog Switch Inputs X0-X3
Y0 – Y3	1,5,2,4	Analog Switch Inputs Y0-Y3
X	13	Analog Switch “X” Output.
Y	3	Analog Switch “Y” Output.
V <sub>cc</sub>	16	Positive Analog and Digital Supply Voltage Input
A	10	Digital Address “A” Input
B	9	Digital Address “B” Input
GND	8	Ground. Connect to digital ground
NC	7	No Connect.
$\overline{\text{ENABLE}}$	6	Digital Enable Input. Normally connected to GND

## Function Table

INPUTS			ON CHANNEL
$\overline{\text{ENABLE}}$	B	A	
L	L	L	X0, Y0
L	L	H	X1, Y1
L	H	L	X2, Y2
L	H	H	X3, Y3
H	X	X	None

X=Don't care

### **ABSOLUTE MAXIMUM RATINGS**

Parameter	Min	Max	Units
V <sub>CC</sub> to GND	-0.3	6	V
Voltage into Any Terminal	-0.3	V <sub>CC</sub> + 0.3	V
Continuous Current into Any Terminal	-20	+20	mA
Peak Current, X <sub>-</sub> , Y <sub>-</sub> (Pulsed at 1ms, 10% duty cycle)	-40	+40	mA
Operating Temperature	-40	+125	°C
Storage Temperature Range	-65	+150	°C

#### **Notes:**

- (1) Stress beyond above listed “Absolute Maximum Ratings” may lead permanent damage to the device. These are stress ratings only and operations of the device at these or any other conditions beyond those indicated in the operational sections of the specifications are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **DC ELECTRICAL CHARACTERISTICS**

( V<sub>CC</sub>=5V, Full = -40°C to +125°C. Typical values are at V<sub>CC</sub>=+25°C, unless otherwise noted )

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP	MAX	UNITS
<b>ANALOG SWITCH</b>							
Analog Signal Range	V <sub>X-</sub> , V <sub>Y-</sub> , V <sub>X</sub> , V <sub>Y</sub>		Full	GND		V <sub>CC</sub>	V
On-Resistance	R <sub>ON</sub>	V <sub>CC</sub> =5V, I <sub>X</sub> , I <sub>Y</sub> =1mA	+25°C		42	58	Ω
			Full			67	
On-Resistance Match Between Channels	ΔR <sub>ON</sub>	V <sub>CC</sub> =5V, I <sub>X</sub> , I <sub>Y</sub> =1mA	+25°C		1	5	Ω
			Full			5.3	
On-Resistance Flatness	R <sub>FLAT(ON)</sub>	V <sub>CC</sub> =5V, I <sub>X</sub> , I <sub>Y</sub> =1mA	+25°C		9	15	Ω
			Full			20	
X <sub>-</sub> , Y <sub>-</sub> Off Leakage Current	I <sub>X(OFF)</sub> , I <sub>Y(OFF)</sub>	V <sub>CC</sub> = 5.0V, V <sub>X-</sub> , V <sub>Y-</sub> = 1V, 4.5V, V <sub>X</sub> , V <sub>Y</sub> = 4.5V, 1V	+25°C		1	1000	nA
X, Y Off Leakage Current	I <sub>X(OFF)</sub> , I <sub>Y(OFF)</sub>	V <sub>CC</sub> = 5.0V, V <sub>X-</sub> , V <sub>Y-</sub> = 1V, 4.5V, V <sub>X</sub> , V <sub>Y</sub> = 4.5V, 1V	+25°C		1	1000	nA
X, Y On Leakage Current	I <sub>X(ON)</sub> , I <sub>Y(ON)</sub>	V <sub>CC</sub> = 5.0V, V <sub>X</sub> , V <sub>Y</sub> = 4.5V, 1V	+25°C		1	1000	nA
<b>DIGITAL CONTROL INPUTS</b>							
Logic Input Logic Threshold High	V <sub>AH</sub> , V <sub>BH</sub> , V <sub>ENABLE</sub>		+25°C	1.7			V

Logic Input Logic Threshold Low	$V_{AL}, V_{BL}, V_{ENABLE}$		+25°C			0.5	V
Input-Current High	$I_{AH}, I_{BH}, I_{ENABLE}$	$V_A, V_B, V_{ENABLE} = V_{CC}$	+25°C		1	1000	nA
Input-Current Low	$I_{AL}, I_{BL}, I_{ENABLE}$	$V_A, V_B, V_{ENABLE} = 0V$	+25°C		1	1000	nA
<b>DYNAMIC CHARACTERISTICS</b>							
Address Transition Time	$t_{TRANS}$	$V_X, V_Y = 3V/0V, R_L = 300\Omega, C_L = 35pF$ , Test Circuit 1	+25°C		100		ns
$\overline{ENABLE}$ Turn-On Time	$t_{ON}$	$V_X, V_Y = 3V, R_L = 300\Omega, C_L = 35pF$ , Test Circuit 2	+25°C		65		ns
$\overline{ENABLE}$ Turn-Off Time	$t_{OFF}$	$V_X, V_Y = 3V, R_L = 300\Omega, C_L = 35pF$ , Test Circuit 2	+25°C		35		ns
Internal A, B Rise Time	$t_R$		+25°C		65		ns
Internal A, B Fall Time	$t_F$		+25°C		60		ns
Break-Before-Make Time Delay	$t_D$	$V_X, V_Y = 3V, R_L = 300\Omega, C_L = 35pF$ , Test Circuit 3	+25°C		68		ns
Charge Injection	Q	$R_S = 0\Omega, C_L = 1nF$ , Test Circuit 4	+25°C		6		pC
Off Isolation	$O_{ISO}$	$f = 1MHz$ , Test Circuit 5	+25°C		-83		dB
Crosstalk	$X_{TALK}$	$f = 1MHz$ , Test Circuit 5	+25°C		-95		dB
Input Off-Capacitance	$C_{X(OFF)}, C_{Y(OFF)}$	$f = 1MHz$ , Test Circuit 6	+25°C		6		pF
Output Off-Capacitance	$C_{X(OFF)}, C_{Y(OFF)}$	$f = 1MHz$ , Test Circuit 6	+25°C		10		pF
Output On-Capacitance	$C_{X(ON)}, C_{Y(ON)}$	$f = 1MHz$ , Test Circuit 6	+25°C		13		pF
-3dB Bandwidth	BW	$R_L = 50\Omega$	+25°C		550		MHz
Total Harmonic Distortion	THD	$R_L = 600\Omega, 5V_{P-P}, f = 20Hz$ to 20kHz	+25°C		0.6		%
<b>POWER REQUIREMENTS</b>							
Power Supply Range	$V_{CC}$		full	2.5		5.5	V
Power Supply Current	$I_{CC}$	$V_{CC} = 5.5V, V_A, V_B, V_{ENABLE} = V_{CC}$ or 0V	+25°C		0.001	1	uA

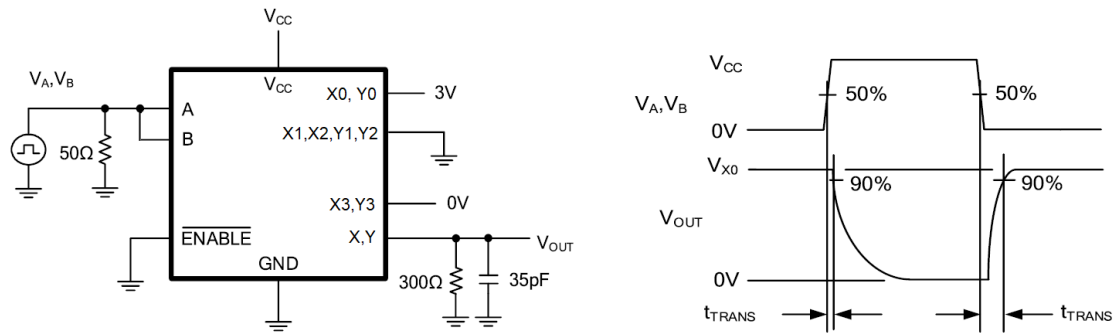
### DC ELECTRICAL CHARACTERISTICS

( $V_{CC}=3.3V$ , Full=-40°C to +125°C. Typical values are at  $V_{CC}=+25^\circ C$ , unless otherwise noted)

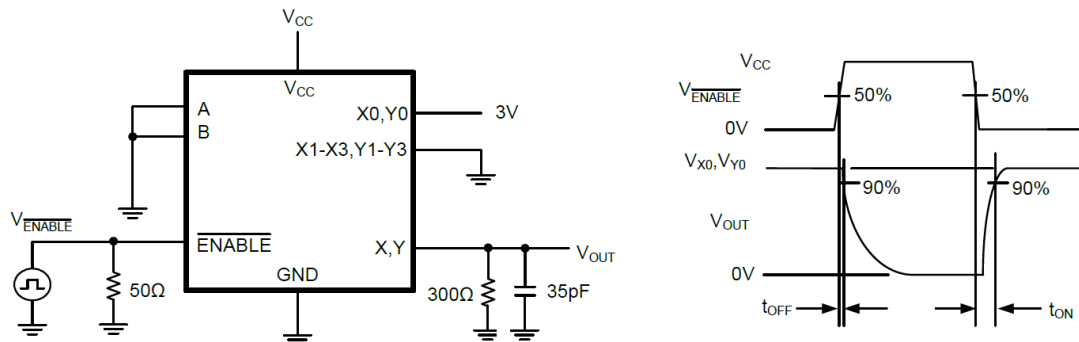
PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP	MAX	UNITS
<b>ANALOG SWITCH</b>							
Analog Signal Range	$V_X, V_Y, V_X, V_Y$		Full	GND		VCC	V

On-Resistance	R <sub>ON</sub>	I <sub>x</sub> , I <sub>y</sub> = 1mA	+25°C		70	110	Ω
			Full			116	
X <sub>-</sub> , Y <sub>-</sub> Off Leakage Current	I <sub>X(OFF)</sub> , I <sub>Y(OFF)</sub>	V <sub>X-</sub> , V <sub>Y-</sub> = 1V, 3V, V <sub>X</sub> , V <sub>Y</sub> = 3V, 1V	+25°C		1	1000	nA
X, Y Off Leakage Current	I <sub>X(OFF)</sub> , I <sub>Y(OFF)</sub>	V <sub>X-</sub> , V <sub>Y-</sub> = 1V, 3V, V <sub>X</sub> , V <sub>Y</sub> = 3V, 1V	+25°C		1	1000	nA
X, Y On Leakage Current	I <sub>X(ON)</sub> , I <sub>Y(ON)</sub>	V <sub>X</sub> , V <sub>Y</sub> = 3V, 1V	+25°C		1	1000	nA
<b>DIGITAL CONTROL INPUTS</b>							
Logic Input Logic Threshold High	V <sub>AH</sub> , V <sub>BH</sub> , V <sub>ENABLE</sub>		25°C	1.7			V
Logic Input Logic Threshold Low	V <sub>AL</sub> , V <sub>BL</sub> , V <sub>ENABLE</sub>		25°C			0.5	V
Input-Current High	I <sub>AH</sub> , I <sub>BH</sub> , I <sub>ENABLE</sub>	V <sub>A</sub> , V <sub>B</sub> , V <sub>ENABLE</sub> = V <sub>CC</sub>	25°C		1	1000	nA
Input-Current Low	I <sub>AL</sub> , I <sub>BL</sub> , I <sub>ENABLE</sub>	V <sub>A</sub> , V <sub>B</sub> , V <sub>ENABLE</sub> = 0V	25°C		1	1000	nA
<b>DYNAMIC CHARACTERISTICS</b>							
Address Transition Time	t <sub>TRANS</sub>	V <sub>X-</sub> , V <sub>Y-</sub> = 3V/0V, R <sub>L</sub> = 300Ω, C <sub>L</sub> = 35pF, Test Circuit 1	+25°C			135	ns
ENABLE Turn-On Time	t <sub>ON</sub>	V <sub>X-</sub> , V <sub>Y-</sub> = 3V, R <sub>L</sub> = 300Ω, C <sub>L</sub> = 35pF, Test Circuit 2	+25°C			90	ns
ENABLE Turn-Off Time	t <sub>OFF</sub>	V <sub>X-</sub> , V <sub>Y-</sub> = 3V, R <sub>L</sub> = 300Ω, C <sub>L</sub> = 35pF, Test Circuit 2	+25°C			50	ns
Internal A, B Rise Time	t <sub>R</sub>		+25°C			85	ns
Internal A, B Fall Time	t <sub>F</sub>		+25°C			65	ns
Break-Before-Make Time Delay	t <sub>D</sub>	V <sub>X-</sub> , V <sub>Y-</sub> = 3V, R <sub>L</sub> = 300Ω, C <sub>L</sub> = 35pF, Test Circuit 3	+25°C			90	ns
Charge Injection	Q	R <sub>S</sub> = 0Ω, C <sub>L</sub> = 1nF, Test Circuit 4	+25°C			5	pC
-3dB Bandwidth	BW	R <sub>L</sub> = 50Ω	+25°C			500	MHz
<b>POWER REQUIREMENTS</b>							
Power Supply Current	I <sub>CC</sub>	V <sub>CC</sub> = 3.6V, V <sub>A</sub> , V <sub>B</sub> , V <sub>ENABLE</sub> = V <sub>CC</sub> or 0V	+25°C		0.001	1	μA

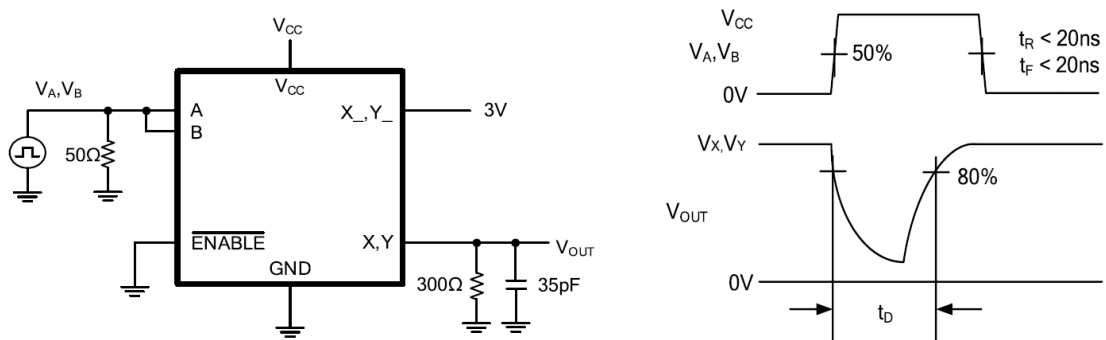
**TEST SETUP CIRCUITS**



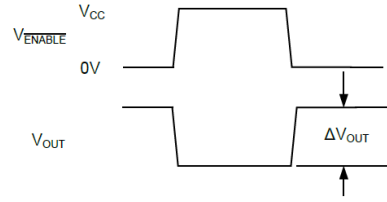
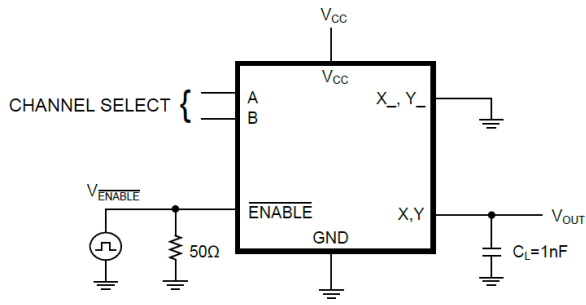
Test Circuit 1. Address Transition Times ( $t_{TRANS}$ )



Test Circuit 2. Switching Times ( $t_{ON}$ ,  $t_{OFF}$ )

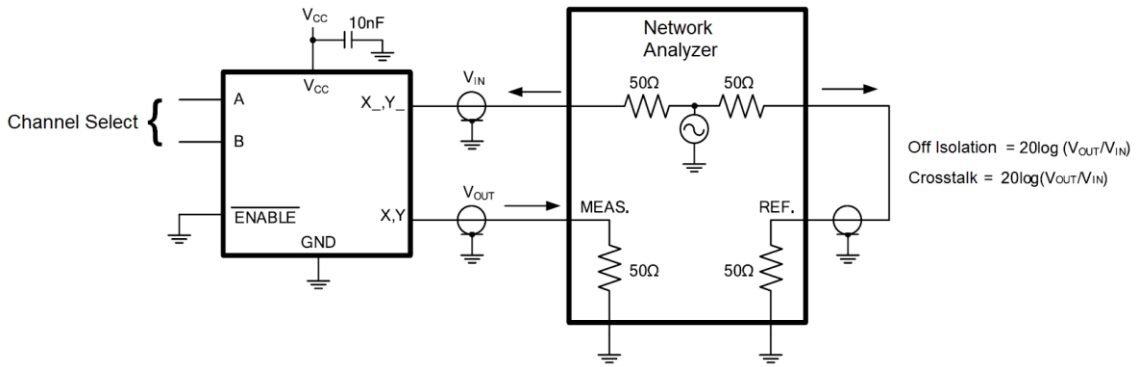


Test Circuit 3. Break-Before-Make Time Delay ( $t_D$ )

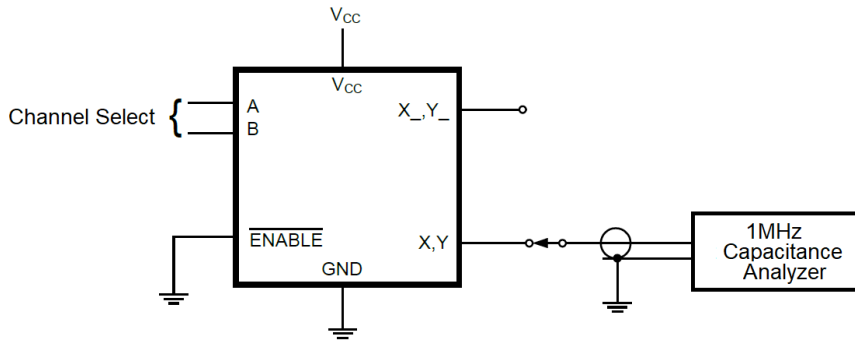


$\Delta V_{OUT}$  is the measured voltage due to charge transfer error Q when the channel turns off  
 $Q = \Delta V_{OUT} \times C_L$

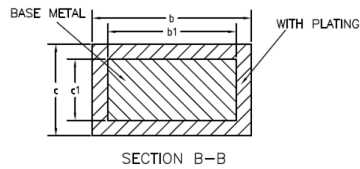
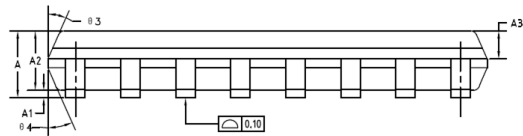
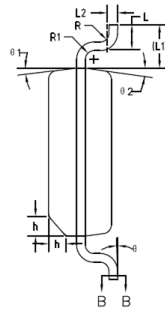
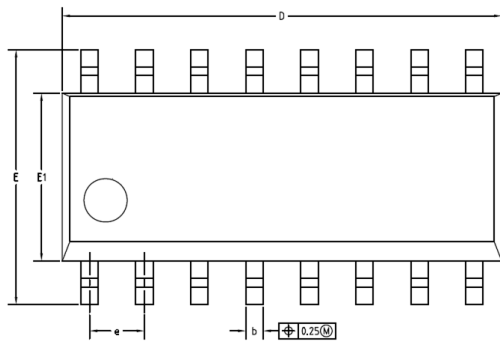
Test Circuit 4. Charge Injection (Q)



Test Circuit 5. Off Isolation and Crosstalk



Test Circuit 6. Capacitance

**PACKAGE OUTLINE DIMENSIONS**
**SOP16**

 COMMON DIMENSIONS  
 (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	—	—	1.75
A1	0.10	0.15	0.25
A2	1.25	1.45	1.65
A3	0.55	0.65	0.75
b	0.35	—	0.51
b1	0.34	0.40	0.45
c	0.17	—	0.25
c1	0.17	0.20	0.23
D	9.80	10.00	10.20
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e	1.27BSC		
L	0.40	0.60	0.80
L1	1.04REF		
L2	0.25BSC		
R	0.07	—	—
R1	0.07	—	—
h	0.30	0.40	0.50
θ	0°	—	8°
θ 1	6°	8°	10°
θ 2	6°	8°	10°
θ 3	5°	7°	9°
θ 4	5°	7°	9°